
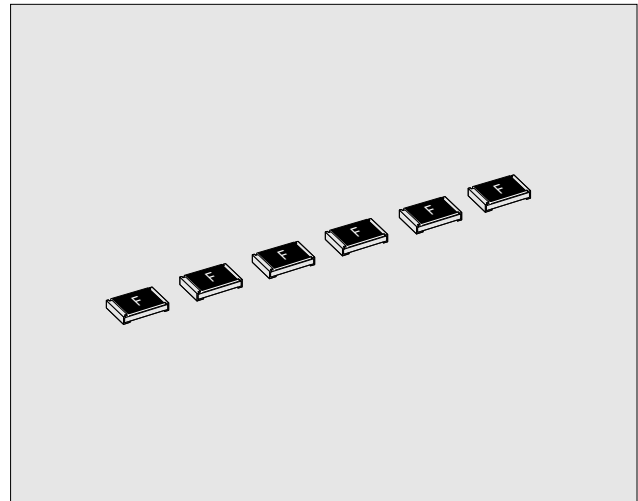


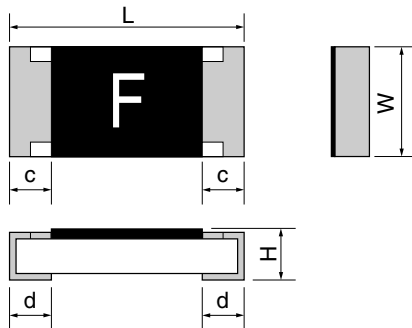
FMC16 Option Code : AB/Low Ohm & Fast Acting

●Features

1. Suitable for over-current protection of the circuit of miniature portable equipment.
2. Low internal resistance compared with FCC/FHC16 AB series for low power consumption and voltage dropping.
3. Pb*1, Halogen*2 and Antimony*3 free product
 - *1 Pb ≤ 1000ppm
 - *2 Cl or Br ≤ 900ppm, Cl+Br ≤ 1500ppm
 - *3 Sb₂O₃ ≤ 900ppm
4. Certified UL, c-UL.
 - File No. : E176847 
5. Major application
 - PC related equipment and peripherals (PC, Hard Drive, Printer etc.).
 - Small portable devices (Mobile phone, PDA Battery Charger etc.).
 - Digital Camera (Digital still camera).
 - Game equipment.
 - LCD monitors, LCD modules.
 - Battery pack.



●Dimension



Current value is marked on the cover coating.
Please refer to Ratings table on next page.

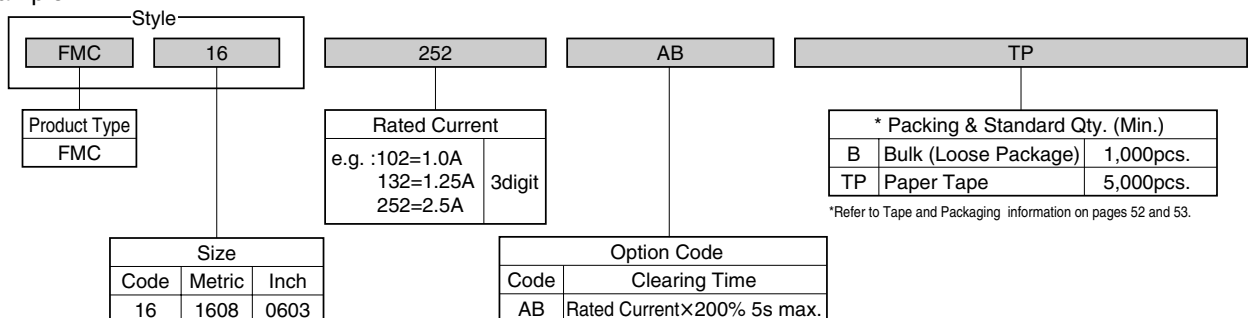
Style	Metric	Inch	L	W	H	c	d	*Unit weight/pc.
FMC16	1608	0603	1.6 ± 0.1	0.8 ^{+0.15} / _{-0.05}	0.45 ± 0.10	0.3 ± 0.15	0.3 ± 0.1	2mg

Unit : mm

*Values for reference

●Part Number Description

Example



CHIP FUSES; RECTANGULAR TYPE

FMC16 Option Code : AB

●Ratings/Option Code : AB (Fast-Acting type)

Size		Style	Rated Current		Internal Resistance m ohm max.	Mark	Interrupting Rating	Electrical Characteristics		Category Temperature Range °C
Metric	Inch		Code	A				Rated Current	Opening time	
1608	0603	FMC16	501	0.5	260	F	32Vd.c. 35A	×100%	4h Min.	-55~+125
			751	0.75	140	A				
			102	1.0	110	L				
			132	1.25	80	M				
			152	1.5	65	H				
			202	2.0	45	S				
			252	2.5	32	T				
			302	3.0	26	R				
			402	4.0	18	X				
			502	5.0	14	Y				

●Performance Characteristics

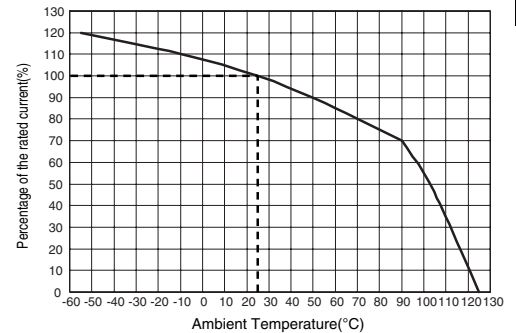
Description	Requirements	Test Methods
Temperature rise on the surface	75°C max.	Ambient temperature : 10°C~30°C Carrying Current : Rated current
Bend strength of the face plating	No visible damage	IEC 60127-4 Clause 8.3 1mm/s, amount of bend : 3 mm
Solderability	At least 95% of the terminal surface must be covered by new solder	IEC 60127-4 Clause 8.5 Be immersed into solder at 235°C for 2s.
Resistance to soldering heat	No visible damage. Meet electrical requirement	IEC 60127-4 Clause 8.7 Be immersed into solder at 260°C for 10s.

Note. Please contact KAMAYA for special applications.

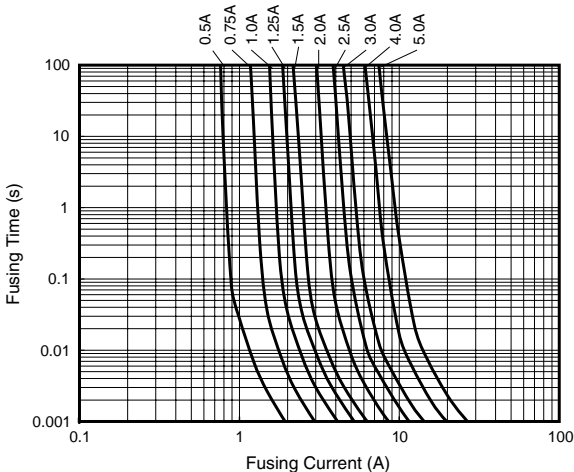
●Recommended Derating for Rated Current

- Nominal Derating
Nominal Derating ≤ 75% of Rated Current
- Temperature Derating
Please refer to the following graph regarding the current derating value for ambient temperature.

Ex.) If FMC16 102AB (Rated Current 1.0A) is used under ambient temperature 70°C,
Kamaya recommends, less than the current value derated as below,
Rated Current : 1.0A × (Nominal Derating : 75% × Temperature Derating : 80%) = 0.6A



●Time / Current Characteristics



●Help Support of Fuse Selection

Please contact kamaya sales Dept, if you need to confirm In-rush Current endurance, Anti-pulse performance etc. We can provide Application Guide for FMC16 selection.

Messrs***
Kamaya Electric Co., Ltd.
Hokkaido Research Center
No. 9670202

Verification of Chip Fuse Application

Item for examination

Series	FMC	Application	15 V d.c.
Style	1608	Rated Current	2.5 A
Option	AB	Ambient	70 deg.C Max.
		Interrupting	4 A

Operating condition

Item for recommend

Size	Style	Rated Current	Options	Interrupting Rating	Notes
FMC16 1608	1608	1.25A, 1.5A, 2.0A, 2.5A, 3.0A	AB	32Vd.c. 35A	Standard Pulse 100A times

Confirmation for Interrupting

Condition	Series	Rated Current
Normal	FMC16	2.5A
Abnormal	FMC16	2.5A

Confirmation for Derating

Rated Current	2.5A
Temperature Derating	80%

Basis of selection

Series	FMC16
Style	1608
Rated Current	2.5A

Confirmations for Rush

Series	FMC16	Rated Current	2.5A	Options	AB
Style	1608	Rated Current	2.5A	Options	AB

Confirmation of Rush

Series	Style	Rated Current	Options	Notes
FMC	16	1.5A	AB	Standard Pulse 100A times

Recommended item: FMC16 150AB